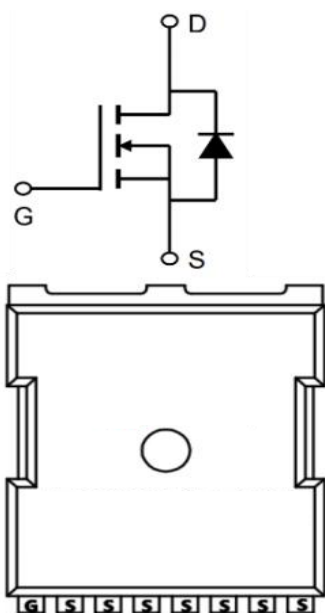


Description

The SX200N15TLG1 uses advanced technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a Battery protection or in other Switching application.



General Features

$V_{DS} = 150V$ $I_D = 200A$

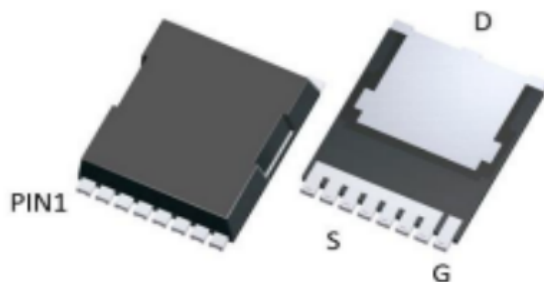
$R_{DS(ON)} < 7.2m\Omega$ @ $V_{GS}=10V$

Application

DC/DC Converter

Power Management Switches

BMS/UPS



Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	150	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_c=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	200	A
$I_D @ T_c=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	140	A
I_{DM}	Pulsed Drain Current	550	A
E_{AS}	Single Pulse Avalanche Energy	506	mJ
I_{AS}	Avalanche Current	53.4	A
$P_D @ T_c=25^\circ C$	Total Power Dissipation ⁴	210	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	0.84	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case	40	$^\circ C/W$

Electrical Characteristics (T_c=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
VDSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	150	-	-	V
IGSS	Gate-body Leakage current	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
IDSS	Zero Gate Voltage Drain Current T _J =25°C	V _{DS} = 100V, V _{GS} = 0V	-	-	1	μA
IDSS	Zero Gate Voltage Drain Current T _J =100°C		-	-	100	
VGS(th)	Gate-Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0	2.9	4.0	V
RDS(on)	Drain-Source on-Resistance ²	V _{GS} = 10V, I _D = 20A	-	6.6	7.5	mΩ
Ciss	Input Capacitance	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz	-	5240	-	pF
Coss	Output Capacitance		-	412	-	
Crss	Reverse Transfer Capacitance		-	10	-	
R _g	Gate Resistance	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz	-	1.7	-	Ω
Q _g	Total Gate Charge	V _{GS} = 10V, V _{DS} = 50V, I _D = 20A	-	18	-	nC
Q _{gs}	Gate-Source Charge		-	10	-	
Q _{gd}	Gate-Drain Charge		-	72	-	
td(on)	Turn-on Delay Time	V _{GS} = 10V, V _{DS} = 50V, R _G = 3Ω, I _D = 20A	-	22	-	ns
t _r	Rise Time		-	115	-	
td(off)	Turn-off Delay Time		-	44	-	
t _f	Fall Time		-	105	-	
VSD	Diode Forward Voltage ²	I _F = 20A, V _{GS} = 0V	-	-	1.2	V
IS	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	-	-	190	A
trr	Body Diode Reverse Recovery Time	I _F = 20A, dI/dt=100A/μs	-	45	-	ns
Q _{rr}	Body Diode Reverse Recovery Charge		-	12	-	nC

Notes:

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、The EAS data shows Max. rating . The test condition is V_{DD}=50V, V_{GS}=10V, L=0.5mH, I_{AS}=45A
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

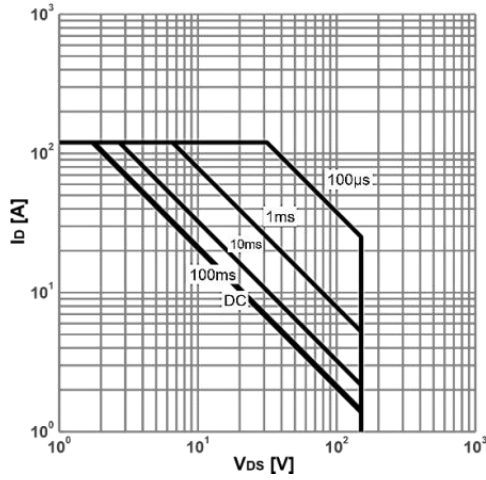


Figure 1. Power dissipation

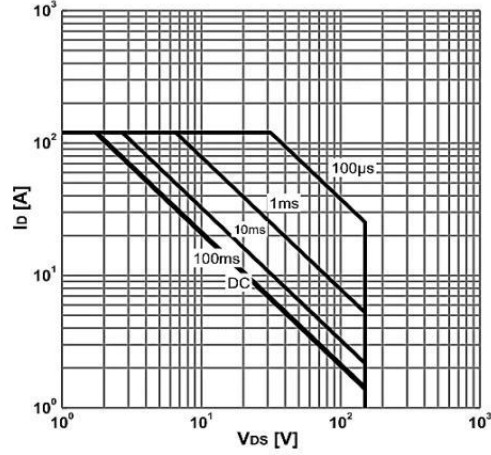


Figure 3. Safe operating area

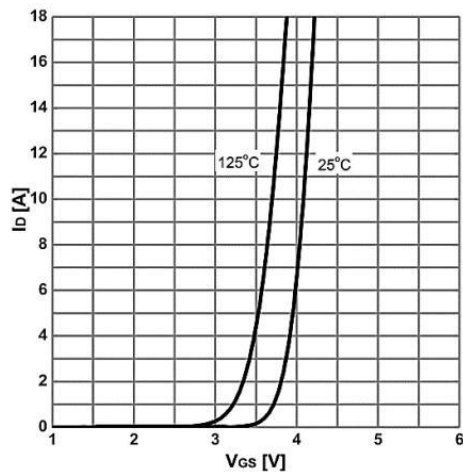


Figure 5. Typ. transfer characteristics

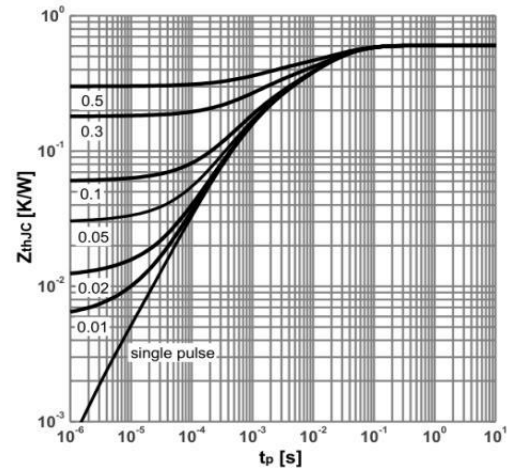


Figure 2. Max. transient thermal impedance

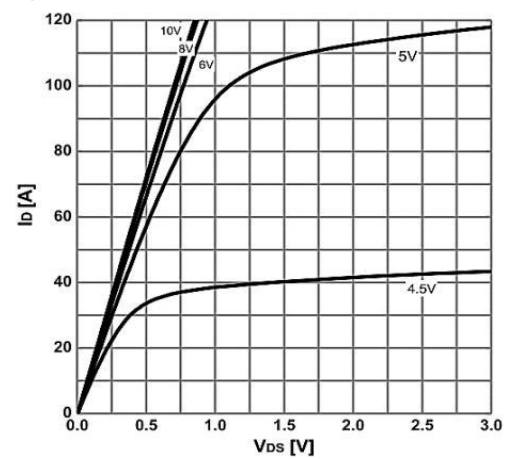


Figure 4. Typ. output characteristics

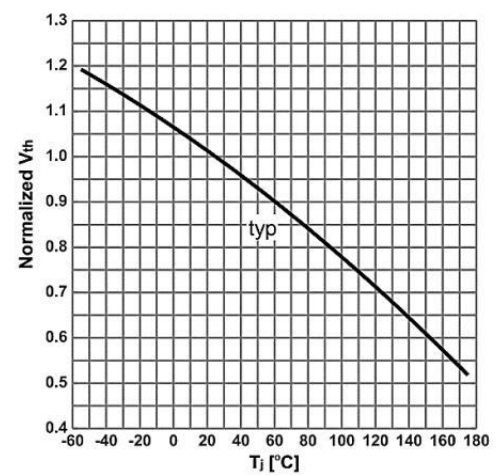


Figure 6. Gate threshold voltage vs. Junction Temperature

Typical Characteristics

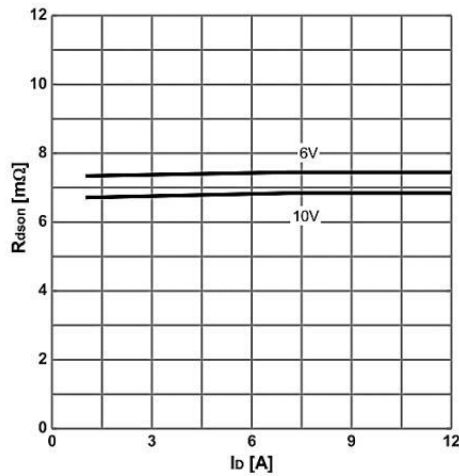


Figure 7. On-state resistance vs. Drain current

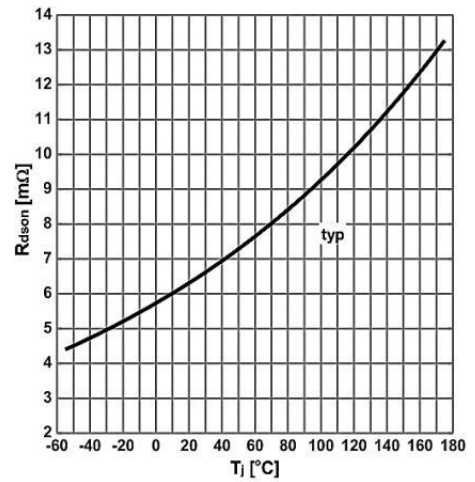


Figure 8. On-state resistance vs. Junction temperature

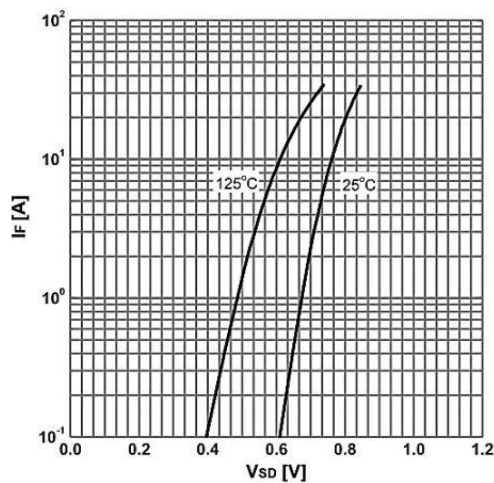


Figure 9. Forward characteristics of reverse diode

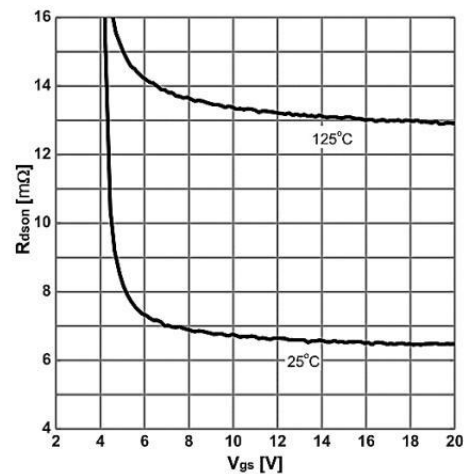


Figure 10. On-state resistance vs. Vgs characteristics

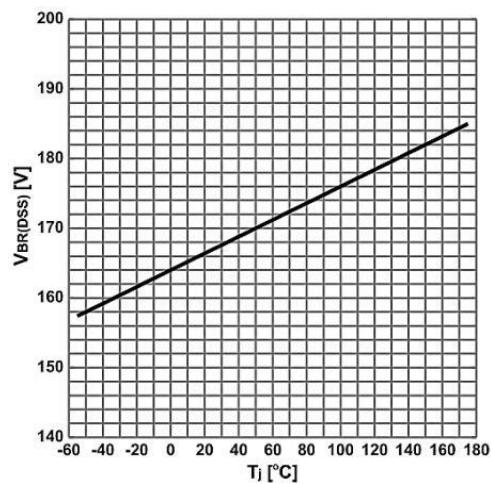


Figure 10: Breakdown Voltage Variation vs. Temperature

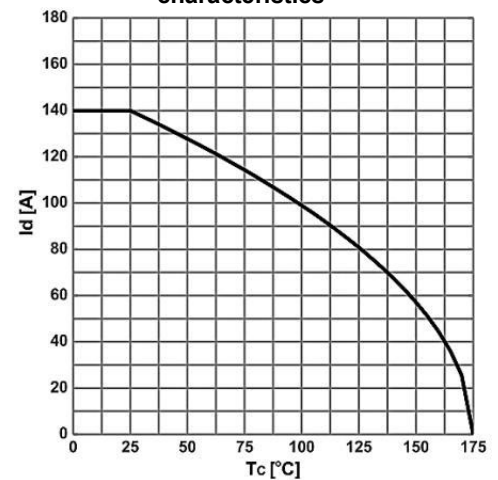
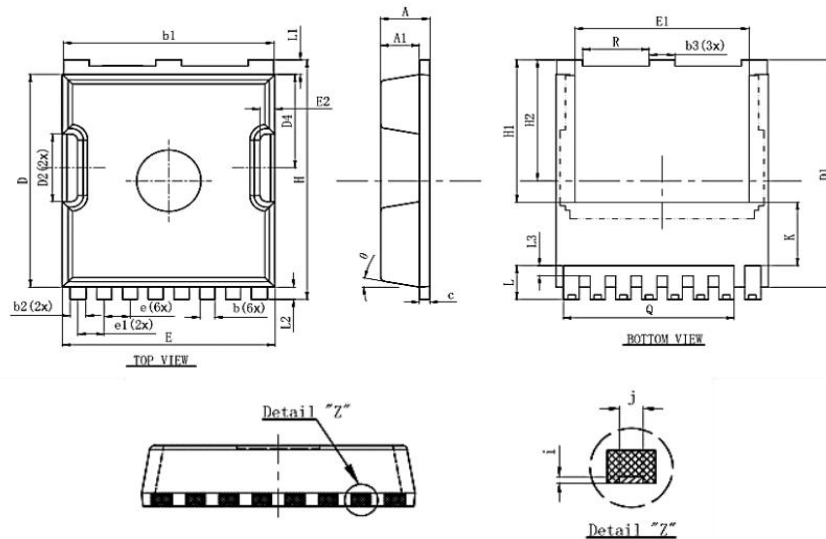


Figure 11: Maximum Drain Current

Package Mechanical Data-TOLLA-8-XZ Single



Symbol	Dimensions In Millimeters		
	Min.	Nom	Max.
A	2.2	2.3	2.4
A1	1.7	1.8	1.9
b	0.6	0.7	0.8
b1	9.7	9.8	9.9
b2	0.65	0.75	0.85
b3	1.1	1.2	1.3
C	0.4	0.5	0.6
D	10.3	10.4	10.5
D1	11.0	11.1	11.2
D2	3.2	3.3	3.4
D4	4.47	4.57	4.67
E	9.8	9.9	10.0
E1	8.0	8.1	8.2
E2	0.5	0.6	0.7
e	1.200 (BSC)		
e1	1.225 (BSC)		
H	11.6	11.7	11.8
H1	6.95BSC		
H2	5.9BSC		
i	0.1REF		
j	0.350REF		
K	3.100REF		
L	1.55	1.65	1.75
L1	0.6	0.7	0.8
L2	0.5	0.6	0.7
L3	0.4	0.5	0.6
Q	7.95REF		
R	3.0	3.1	3.2
θ	10°REG		

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	TOLLA-8L		2000